

## **LOCTITE ECCOBOND UF 1175**

December 2021

#### PRODUCT DESCRIPTION

LOCTITE ECCOBOND UF 1175 provides the following product characteristics:

Technology	Epoxy
Appearance	White liquid
Cure	Heat cure
Product Benefits	Fast cure
	One component
	Controlled flow
	Easy dispensability without stringing
	Low CTE
Application	Electronic encapsulants, Circuit board underfill

LOCTITE ECCOBOND UF 1175 partial underfill is formulated for use on large chip sizes, providing good UPH and reliability.

#### TYPICAL PROPERTIES OF UNCURED MATERIAL

Viscosity, Brookfield CP51, 25 °C, mPa·s (cP):	
Speed 5 rpm	35,295
Thixotropic Index (0.5/5 rpm)	1.05
Specific Gravity, g/cm³	1.65
Work Life @ 25°C, viscosity, in syringe, day	1
Shelf Life @ -20°C, days	180

## TYPICAL CURING PERFORMANCE Cure Schedule

15 minutes @ 120°C

The above cure profile is a guideline recommendation. These cure conditions (time and temperature) may vary based on customers' experience and specific application requirements, as well as customer curing equipment, oven loading and actual oven temperatures.

#### TYPICAL PROPERTIES OF CURED MATERIAL

Sample cured 15 minutes @ 120°C

#### **Physical Properties**

Coefficient of Thermal Expansion, TMA: Below Tg, ppm/°C

Above Tg, ppm/°C 68
Glass Transition Temperature (Tg) by TMA, °C 154
Storage Modulus, @ 25°C, DMA, N/mm² 13,984

19

#### **Adhesion Properties**

Die Shear Strength:

3 x 3 mm Si die on FR4, kg-f

31

#### **GENERAL INFORMATION**

For safe handling information on this product, consult the Safety Data Sheet, (SDS).

#### THAWING:

- This product is packed and shipped in dry ice packs to prevent excessive temperature exposure during shipping.
- 2. Allow material to reach room temperature before use.
- 3. After removing from the freezer, set the syringes to stand vertically while thawing.
- 4. Once material has reached room temperature, the adhesive should not be re-refrigerated.

#### **DIRECTIONS FOR USE**

- LOCTITE ECCOBOND UF 1175 can be applied by jet dispense.
- When applied by jetting, nozzle heating of 50 to 60°C is recommended.
- 3. For faster flow, board should be heated to 70 to 100°C.

#### STORAGE

Store product in the unopened container in a dry location. Storage information may be indicated on the product container labeling.

Optimal Storage: -20°C. Storage below -40°C or above -15°C can adversely affect product properties.

Material removed from containers may be contaminated during use. Do not return product to the original container. Henkel Corporation cannot assume responsibility for product which has been contaminated or stored under conditions other than those previously indicated. If additional information is required, please contact your local Henkel Representative.



Reference 2

#### Conversions

(°C x 1.8) + 32 = °F kV/mm x 25.4 = V/mil mm / 25.4 = inches N x 0.225 = lb/F N/mm x 5.71 = lb/in psi x 145 = N/mm<sup>2</sup> MPa = N/mm<sup>2</sup> N·m x 8.851 = lb·in N·m x 0.738 = lb·ft N·mm x 0.142 = oz·in mPa·s = cP

#### Not for product specifications

The technical data contained herein are intended as reference only. Please contact your local Henkel representative for assistance and recommendations on the specifications of this product.

#### Disclaimer

The information provided in this Technical Data Sheet (TDS) including the recommendations for use and application of the product are based on our knowledge and experience of the product as at the date of this TDS. The product can have a variety of different applications as well as differing application and working conditions in your environment that are beyond our control. Henkel is, therefore, not liable for the suitability of our product for the production processes and conditions in respect of which you use them, as well as the intended applications and results. We strongly recommend that you carry out your own prior trials to confirm such suitability of our product. Any liability in respect of the information in the Technical Data Sheet or any other written or oral recommendation(s) regarding the concerned product is excluded, except if otherwise explicitly agreed and except in relation to death or personal injury caused by our negligence and any liability under any applicable mandatory product liability law.

# In case products are delivered by Henkel Belgium NV, Henkel Electronic Materials NV, Henkel Nederland BV, Henkel Technologies France SAS and Henkel France SA please additionally note the following:

In case Henkel would be nevertheless held liable, on whatever legal ground, Henkel's liability will in no event exceed the amount of the concerned delivery.

## In case products are delivered by Henkel Colombiana, S.A.S. the following disclaimer is applicable:

The information provided in this Technical Data Sheet (TDS) including the recommendations for use and application of the product are based on our knowledge and experience of the product as at the date of this TDS. Henkel is, therefore, not liable for the suitability of our product for the production processes and conditions in respect of which you use them, as well as the intended applications and results. We strongly recommend that you carry out your own prior trials to confirm such suitability of our product.

Any liability in respect of the information in the Technical Data Sheet or any other written or oral recommendation(s) regarding the concerned product is excluded, except if otherwise explicitly agreed and except in relation to death or personal injury caused by our negligence and any liability under any applicable mandatory product liability law.

## In case products are delivered by Henkel Corporation, or Henkel Canada Corporation, the following disclaimer is applicable:

The data contained herein are furnished for information only and are believed to be reliable. We cannot assume responsibility for the results obtained by others over whose methods we have no control. It is the user's responsibility to determine suitability for the user's purpose of any production methods mentioned herein and to adopt such precautions as may be advisable for the protection of property and of persons against any hazards that may be involved in the handling and use thereof. In light of the foregoing, Henkel Corporation specifically disclaims all warranties expressed or implied, including warranties of merchantability or fitness for a particular purpose, arising from sale or use of Henkel Corporation's products. Henkel Corporation specifically disclaims any liability for consequential or incidental damages of any kind, including lost profits. The discussion herein of various processes or compositions is not to be interpreted as representation that they are free from domination of patents owned by others or as a license under any Henkel Corporation patents that may cover such processes or compositions. We recommend that each prospective user test his proposed application before repetitive use, using this data as a guide. This product may be covered by one or more United States or foreign patents or patent applications.

#### Trademark usage

Except as otherwise noted, all trademarks in this document are trademarks of Henkel Corporation in the U.S. and elsewhere. ® denotes a trademark registered in the U.S. Patent and Trademark Office.